Characteristics 1N5908, SM5908

### 1 Characteristics

Table 1. Absolute maximum ratings  $(T_{amb} = 25 \text{ °C})$ 

Symbol	Parameter	Value	Unit	
P <sub>PP</sub>	Peak pulse power dissipation (1)	$T_j$ initial = $T_{amb}$	1500	W
T <sub>stg</sub>	Storage temperature range	-65 to +175	° C	
Tj	Operating junction temperature range	-55 to +175	° C	
TL	Maximum lead temperature for soldering during 10 s.	260	° C	

<sup>1.</sup> For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal resistances

Symbol	Parameter	Value	Unit	
В	Junction to leads	SMC	15	
$R_{th(j-l)}$	Junction to leads	DO-201	20	° C/W
R <sub>th(j-a)</sub>	Junction to ambient on printed circuit on recommended pad layout		90	C/VV
	Junction to ambient	DO-201	75	

Figure 1. Electrical characteristics - definitions

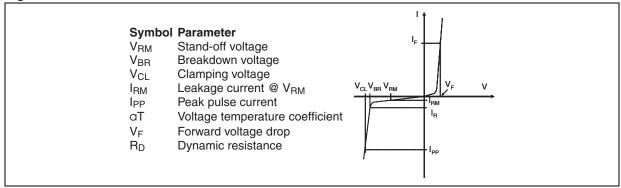
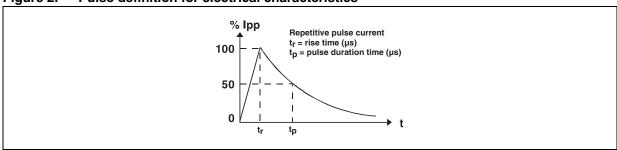


Figure 2. Pulse definition for electrical characteristics



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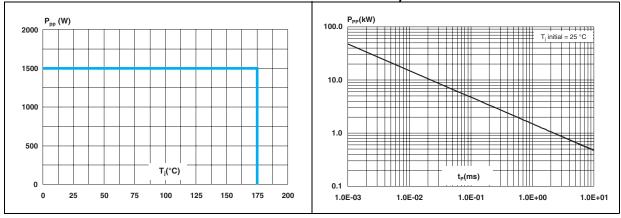
Table 3. Electrical characteristics - parameter values ( $T_{amb} = 25$  °C)

	I <sub>RM</sub> @V <sub>RM</sub>		V <sub>BR</sub> @I <sub>R</sub> <sup>(1)</sup>		V <sub>CL</sub> @Ι <sub>ΡΡ</sub> , 10/1000 μs		V <sub>CL</sub> @I <sub>PP</sub> , 10/1000 μs		V <sub>CL</sub> @I <sub>PP</sub> , 10/1000 μs		α <b>T <sup>(2)</sup></b>	С
Order code	max		min		max		max		max		max	typ
	μΑ	V	V	mA	V	A <sup>(3)</sup>	V	A <sup>(3)</sup>	٧	A <sup>(3)</sup>	10-4/ °C	pF
1N5908	300	5	6	1	7.6	30	8	60	8.5	120	5.7	9500
SM5908	300	500 5	5 6	1   7.0	7.0	30	0	00	0.5	120	5.7	9300

- 1. Pulse tes:  $t_p < 50 \text{ ms}$
- 2. To calculate  $V_{BR}$  or  $V_{CL}$  versus junction temperature, use the following formulas:  $V_{BR} @ T_J = V_{BR} @ 25^{\circ}C \ x \ (1 + \alpha T \ x \ (T_J 25))$   $V_{CL} @ T_J = V_{CL} @ 25^{\circ}C \ x \ (1 + \alpha T \ x \ (T_J 25))$
- 3. Surge capability given for both directions

Figure 3. Peak pulse power dissipation versus initial junction temperature

Figure 4. Peak pulse power versus exponential pulse duration (T<sub>i</sub> initial = 25 °C)



Characteristics 1N5908, SM5908

Figure 5. Clamping voltage versus peak pulse current (exponential waveform, typical values)

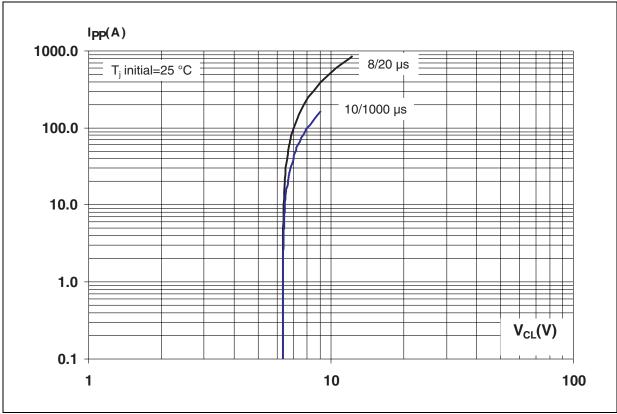
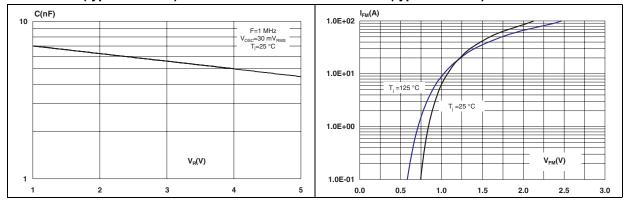


Figure 6. Junction capacitance versus reverse applied voltage (typical values)

Figure 7. Peak forward voltage drop versus peak forward current (typical values)

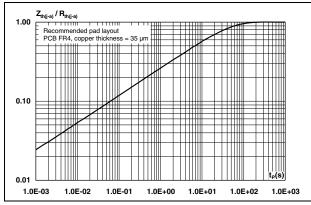


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1N5908, SM5908 Characteristics

Figure 8. Relative variation of thermal impedance, junction to ambient, versus pulse duration (SMC)

Figure 9. Relative variation of thermal impedance, junction to ambient, versus pulse duration (DO-201)



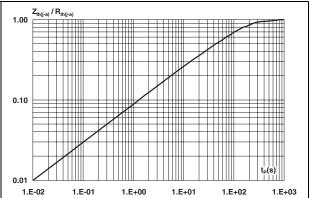
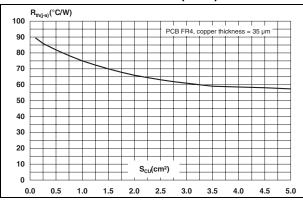
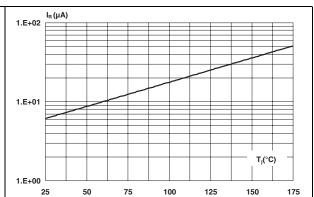


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead (SMC)

Figure 11. Leakage current versus junction temperature (typical values)





**Package information** 1N5908, SM5908

#### 2 **Package information**

- Case: JEDEC DO-214AB molded plastic over planar junction
- Terminals: solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy is rated UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. **SMC dimensions** 

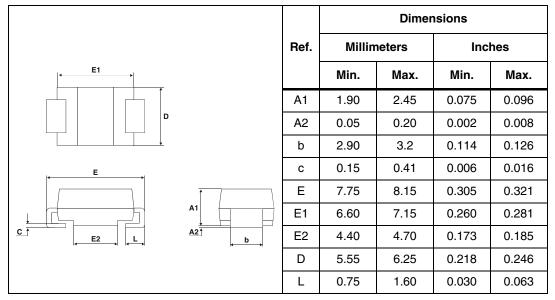
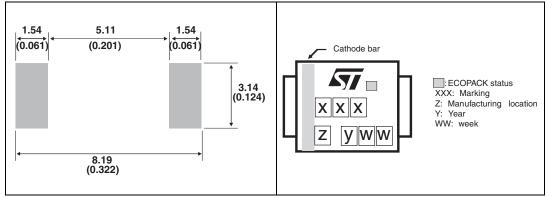


Figure 12. SMC footprint dimensions mm Figure 13. SMC marking layout<sup>(1)</sup> (inches)



Marking layout can vary according to assembly location.

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1N5908, SM5908 Package information

Table 5. DO-201 Dimensions

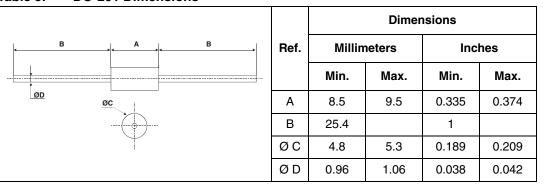
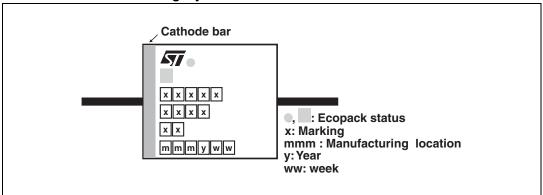


Table 6. DO-201 marking layout



# 3 Ordering information

Table 7. Ordering information

Order code	Marking	Package Weight		Base qty	Delivery mode	
SM5908	MDC	SMC	0.25 g	2500	Tape and reel	
1N5908	1N5908 DO-201 0.9 g 600 Ammo		Ammopack			

# 4 Revision history

Table 8. Document revision history

Date Revision		Changes		
Aug-1999	2A	Previous release		
20-Sep-2011	3	Added cathode bands. Added standards compliance statements. Updated <i>Description</i> . Updated <i>Table 1</i> and <i>Table 2</i> . Updated Figures 3 through 11. Updated <i>Section 2: Package information</i> .		

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